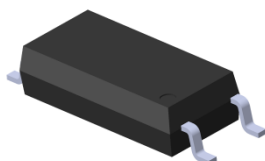
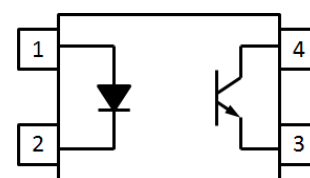


Preliminary

4 PIN LONG CREEPAGE SOP PHOTOTRANSISTOR PHOTOCOUPLER EV101U-G Series



Schematic



Pin Configuration

1. Anode
2. Cathode
3. Emitter
4. Collector

Features:

- Halogens free
(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)
- Compliance with EU REACH
- Pb free and RoHS compliant
- Current transfer ratio
(CTR: 50~400% at $I_F = 0.5\text{mA}$, $V_{CE} = 5\text{V}$)
- Operating temperature $-40^\circ\text{C} \sim 125^\circ\text{C}$
- High isolation voltage between input and output (Viso=5000 V rms)
- UL and cUL approved (No. E214129)
- VDE approved (No. 40028391)
- Qualified to AEC-Q101 test guidelines
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

This is a preliminary specification intended for design purposes and subject to change without prior notice.

Description

The EV101U-G series devices consist of an infrared emitting diode, optically coupled to a phototransistor detector encapsulated with green compound.

They are packaged in a 4-pin SOP package

Applications

- DC-DC Converters
- Programmable controllers
- Telecommunication equipments
- Signal transmission between circuits of different potentials and impedances

Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I_F	50	mA
	Reverse voltage	V_R	5	V
	Power dissipation	P_D	70	mW
Output	Power dissipation	P_C	150	mW
	Collector current	I_C	30	mA
	Collector-Emitter voltage	V_{CEO}	60	V
	Emitter-Collector voltage	V_{ECO}	5	V
Total Power Dissipation		P_{TOT}	200	mW
Isolation Voltage* ¹		V_{ISO}	5000	Vrms
Operating temperature		T_{OPR}	-40 ~ +125	°C
Storage temperature		T_{STG}	-40 ~ +150	°C
Soldering Temperature* ²		T_{SOL}	260	°C

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

*2 For 10 seconds

Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward voltage	V_F	-	1.3	1.6	V	$I_F = 1\text{mA}$
Reverse current	I_R	-	-	10	μA	$V_R = 5\text{V}$
Input capacitance	C_{in}	-	30	250	pF	$V = 0, f = 1\text{kHz}$

Output

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Collector-Emitter dark current	I_{CEO}	-	-	100	nA	$V_{CE} = 20\text{V}, I_F = 0\text{mA}$
Collector-Emitter breakdown voltage	BV_{CEO}	60	-	-	V	$I_C = 0.1\text{mA}$
Emitter-Collector breakdown voltage	BV_{ECO}	5	-	-	V	$I_E = 0.1\text{mA}$

Transfer Characteristics (Ta=25°C unless specified otherwise)

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Current Transfer Ratio	EV101U	50	-	600	%	$I_F = 0.5\text{mA}, V_{CE} = 5\text{V}$
	EV101UA	100	-	200	%	
	EV101UB	150	-	300	%	
	EV101UC	200	-	400	%	
Collector Emitter saturation voltage	$V_{CE(sat)}$	-	-	0.35	V	$I_F = 3\text{mA}, I_C = 1.6\text{mA}$
Isolation resistance	R_{IO}	5×10^{10}	-	-	Ω	$V_{IO} = 500\text{Vdc}, 40\sim 60\% \text{ R.H.}$
Floating capacitance	C_{IO}	-	0.3	1.0	pF	$V_{IO} = 0, f = 1\text{MHz}$
Turn-on time	t_{on}	-	1	-	μs	$V_{CC} = 5\text{V}, I_F = 16\text{mA}, R_L = 1.9\text{K}\Omega$
Turn-off time	t_{off}	-	50	-	μs	

* Typical values at Ta= 25°C

Typical Electro-Optical Characteristics Curves

Figure 1. Forward Current vs Forward Voltage

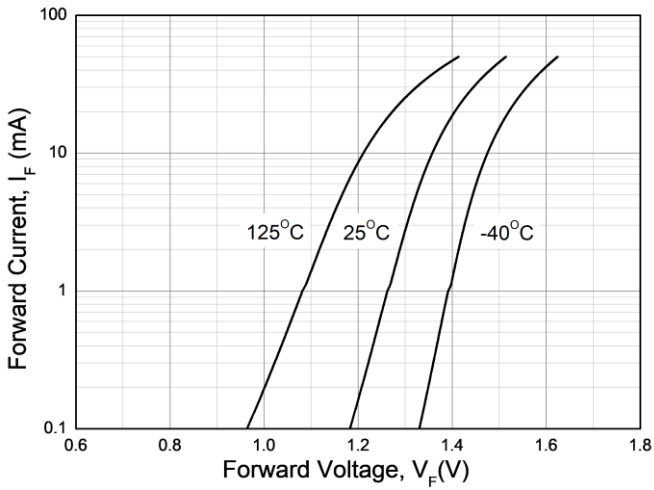


Figure 2. Collector Current vs. Forward Current

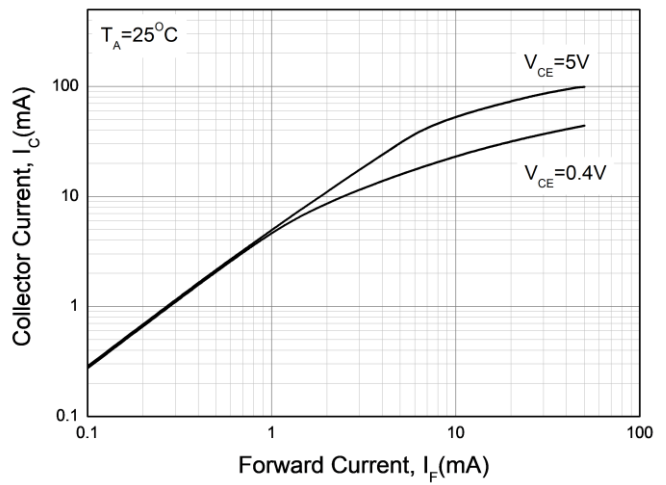


Figure 3. Normalized Current Transfer Ratio vs. Forward Current

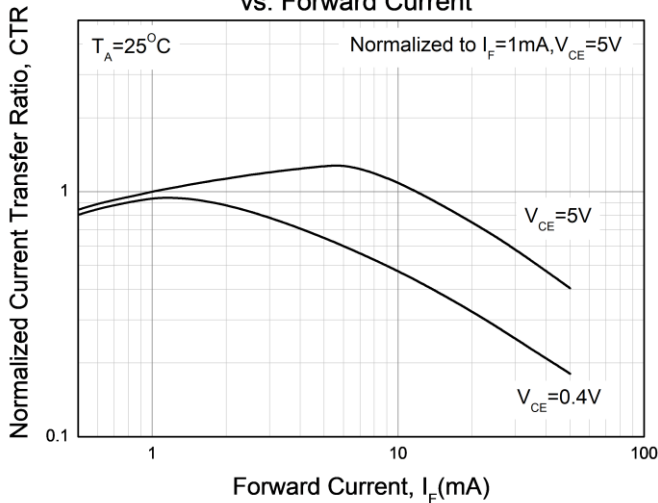


Figure 4. Collector Current vs. Collector Emitter Voltage

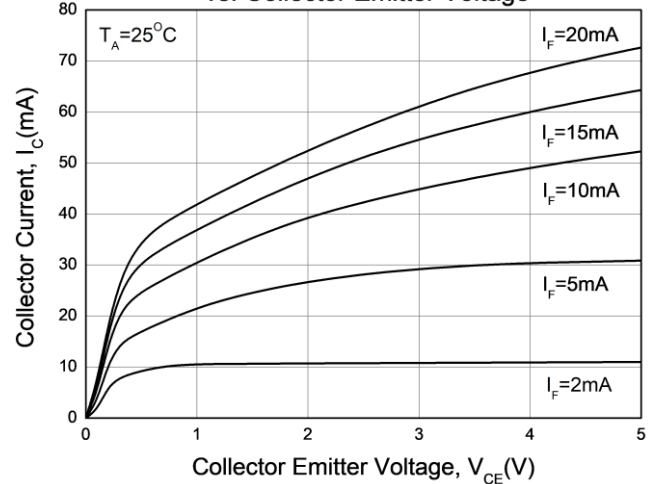


Figure 5. Collector Current vs. Collector Emitter Voltage

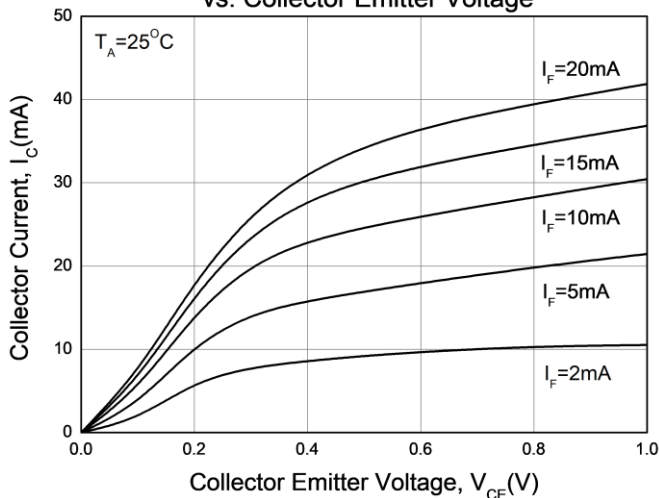


Figure 6. Collector Current vs. Ambient Temperature

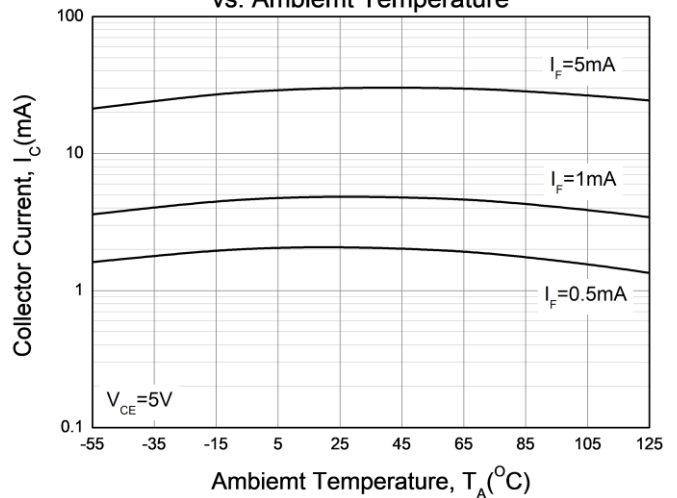


Figure 7. Current Transfer Ratio vs. Ambient Temperature

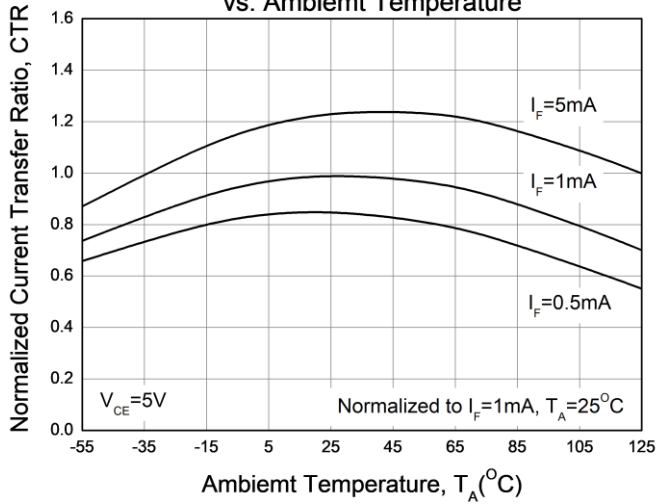


Figure 8. Collector Dark Current vs. Ambient Temperature

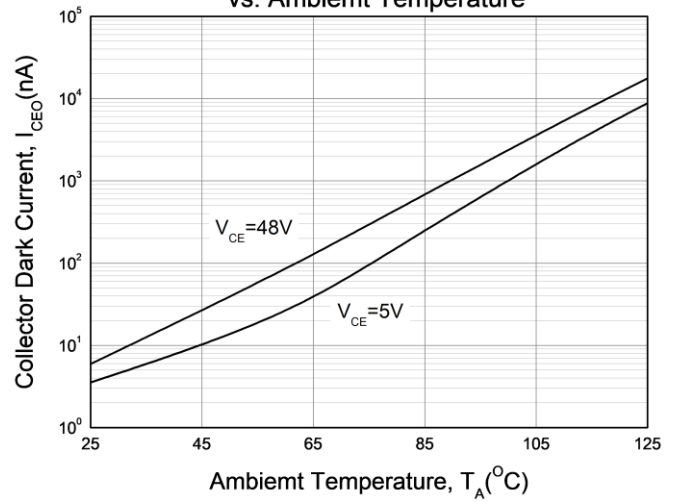


Figure 9. Switching Speed vs. Load resistance

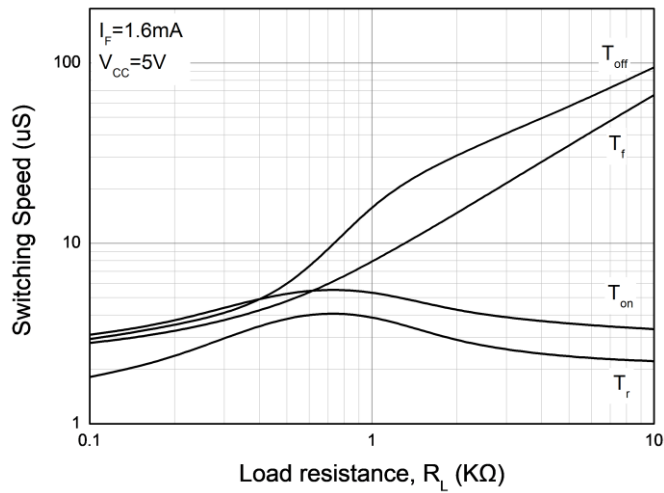


Figure 10. Collector-Emitter Saturation Voltage vs. Ambient Temperature

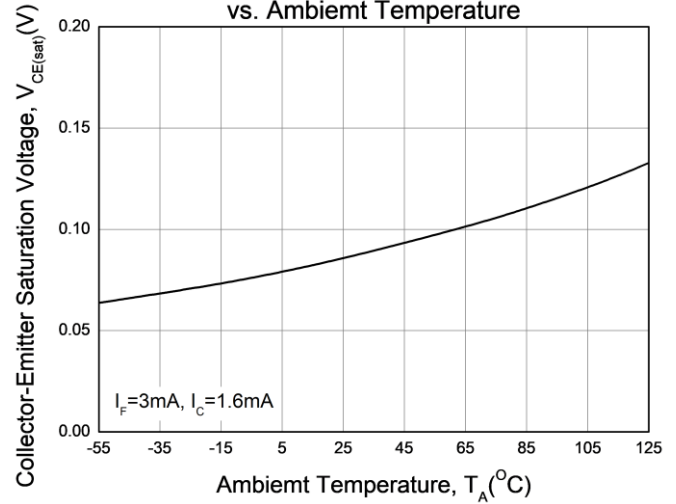
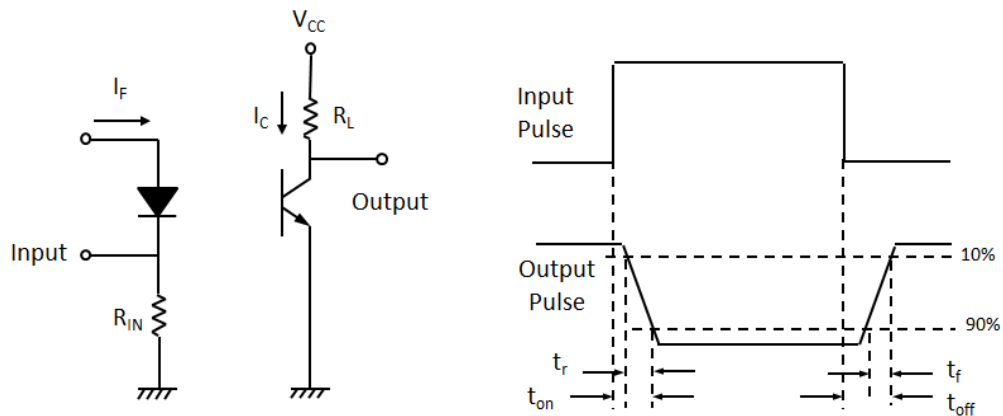


Figure 11. Switching Time Test Circuit & Waveforms



Order Information

Part Number

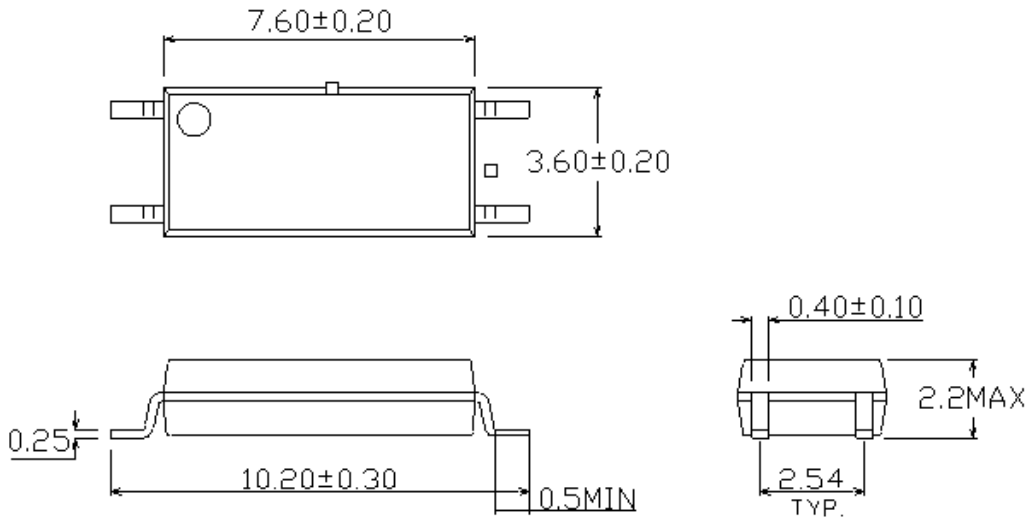
EV101U(X)(Y)-VG

Notes

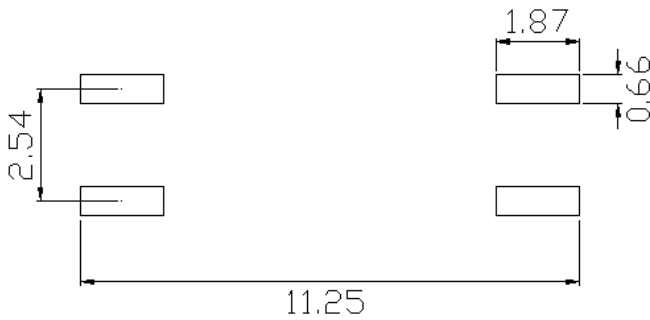
- X = CTR Rank (A, B, C or none)
- Y = Tape and reel option (TA, TB or none).
- V = VDE (optional)
- G = Halogens free

Option	Description	Packing quantity
None	Standard SMD option	100 units per tube
-V	Standard SMD option + VDE	100 units per tube
(TA)	TA Tape & reel option	3000 units per reel
(TB)	TB Tape & reel option	3000 units per reel
(TA)-V	TA Tape & reel option + VDE	3000 units per reel
(TB)-V	TB Tape & reel option + VDE	3000 units per reel

Package Dimension (Dimensions in mm)



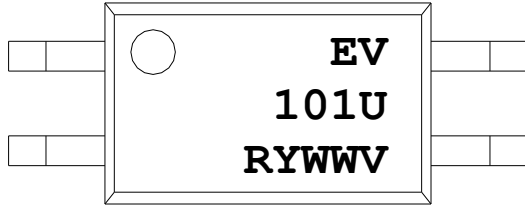
Recommended pad layout for surface mount leadform



Notes

Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

Device Marking

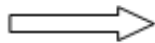
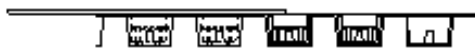
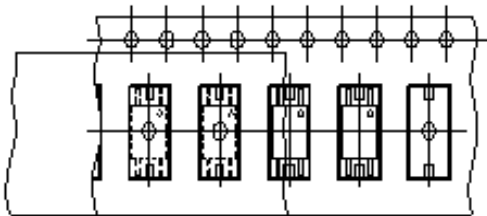


Notes

EV	denotes EVERLIGHT
101U	denotes Device Number
R	denotes CTR Rank (A, B ,C or none)
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE (optional)

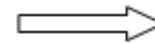
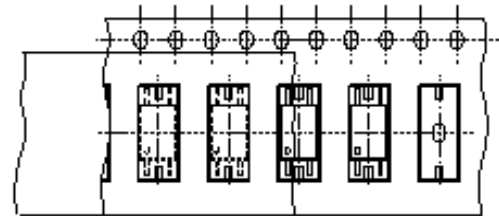
Tape & Reel Packing Specifications

Option TA



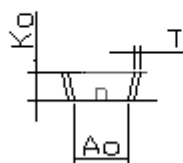
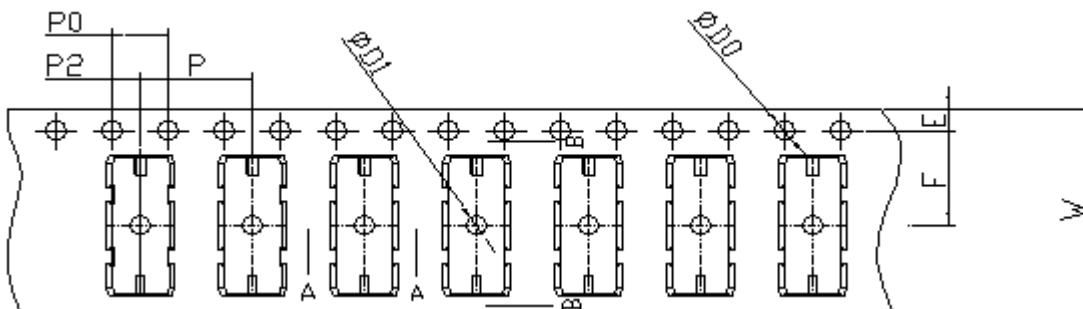
Direction of feed from reel

Option TB



Direction of feed from reel

Tape dimensions

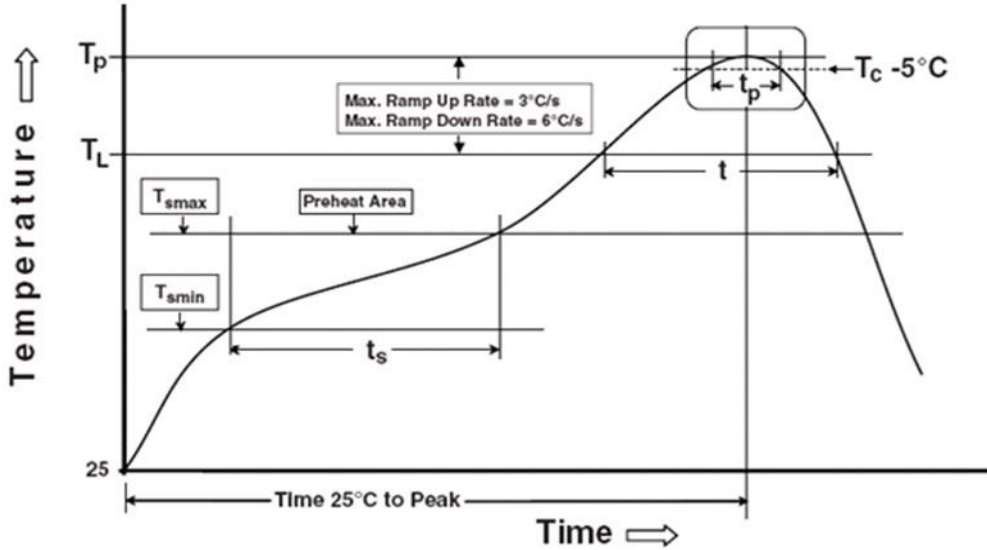


Dimension No.	Ao	Bo	Do	D1	E	F
Dimension (mm)	3.9 ± 0.10	10.82 ± 0.10	1.5 ± 0.10	1.5 ± 0.10	1.75 ± 0.10	7.5 ± 0.10
Dimension No.	Po	P	P2	T	W	Ko
Dimension (mm)	4.0 ± 0.10	8.0 ± 0.10	2.0 ± 0.10	0.4 ± 0.05	16.0 ± 0.30	2.25 ± 0.10

Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Notes

Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max

Other

Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_p)	260°C
Time within 5 °C of Actual Peak Temperature: $T_p - 5^\circ\text{C}$	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

DISCLAIMER

1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
2. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
3. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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